



SPANSION LLC  
915 DeGuigne Drive, P.O. Box 3453  
Sunnyvale, California 94088-3453, USA

September 20, 2007

**Obsolescence Notification No:** 2659

**Subject:** **Obsolescence of the Type 2, 256 SDRAM Multi-Chip Packages (MCPs) products listed below**

Spansion LLC is announcing the obsolescence type 2, 256 SDRAM, and all valid combinations of the Multi-Chip Packages (MCPs) products listed below:

**Product Identification:** S72WS256NEEBAWUB, S72WS256NEEBFWUB, S98WS512NE0FW001, S98WS512PE0FW005

**Package Types:** TSB103, FT137

**Product Line:** WSD – Wireless Solutions Division

**Description of Obsolescence:** Obsolescence of MCP Ordering Part Numbers (OPNs), built with 256 SDRAM, Type 2.

**Reason for Obsolescence:** These products are being removed from Spansion's portfolio due to commercial die used in the MCPs being end-of-life by the commercial die supplier.

**Application Impact:** Consolidation of product offerings.

**Replacement Parts:** Please contact your Spansion sales representative for the appropriate replacement MCPs with SDRAM, type 5, or the next revision die of type 2 SDRAM.

**Last Order Date** March 20, 2008

Obsolescence No. 2659  
09/20/07



**Last Shipment Date:** September 20, 2008

**Products Affected By This Obsolescence (part numbers):**

S72WS256NEEBAWUB

S72WS256NEEBFWUB0#

S98WS512NE0FW0010C

S72WS256NEEBFWUB0

S72WS256NEEBFWUB0G

S98WS512NE0FW0010G